



Investor Update

Jeremy Wang 王志高

Chairman & CEO

Insyde Software Corp. 系微股份有限公司

February, 2026

Safe Harbor Notice

- The statements of its current expectations are forward looking statements subject to significant risks and uncertainties and actual results may differ materially from those contained in the forward-looking statements.
- Except as required by law, we undertake no obligation to update any forward-looking statement, whether as a result of new information, future events, or otherwise.



Agenda

> About Insyde

> Product Portfolio

> Recent Update

> Financial Review

> Q&A

About Insyde®

6231.TWO

Insyde Software

- Founded in 1998 by PCT Chairman Jeremy Wang and SystemSoft EVP Jonathan Joseph
- Business started via acquisition of SystemSoft's BIOS division
- IPO January 23, 2003 (6231.TWO)
- Headquarters: Taipei, Taiwan



**#1 BIOS Vendor for Notebooks
by Market Share !**



Worldwide Presence

- **Headquarter at Taipei, Taiwan**
- Subsidiaries at Massachusetts(USA) and Shanghai (China)
- Representatives in Japan and Europe
- WW Employee numbers : 670+

Taiwan

US

China

Japan

Europe

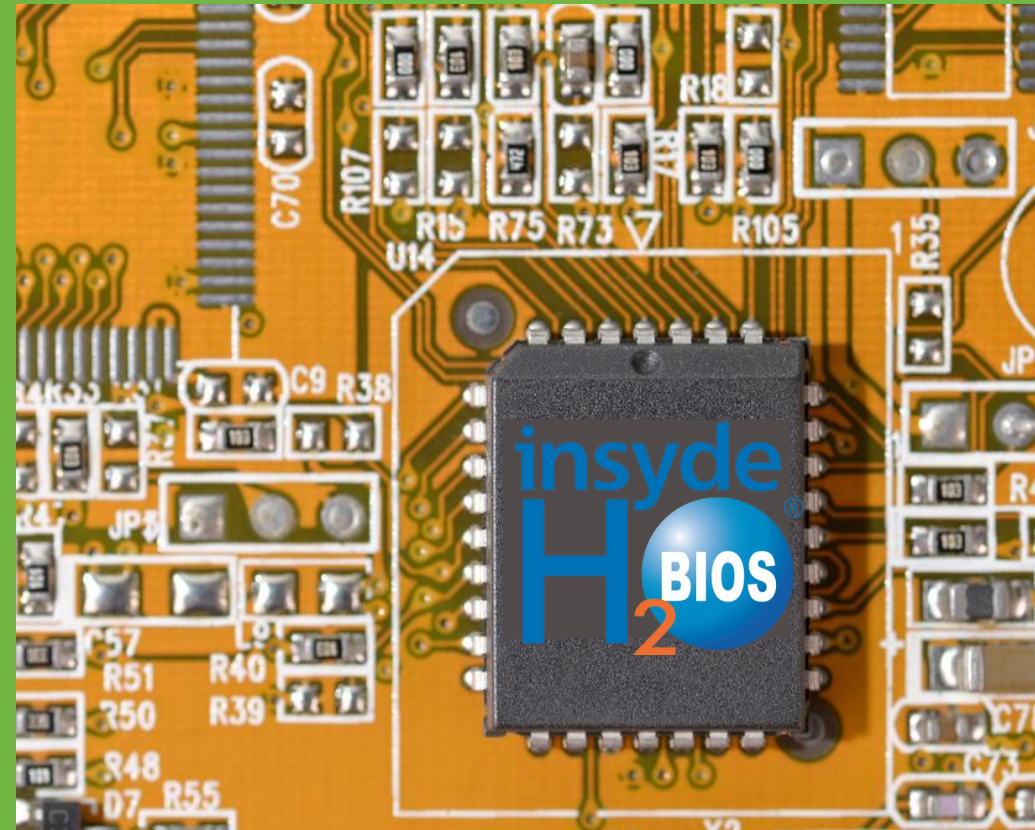


WW Employee numbers : 670+

BIOS – UEFI Firmware

BIOS is stored in the Flash memory and mounted on the motherboard.

- Activated when power button is pushed
- Diagnostic and setup the H/W
- Load and Run OS (ex. Windows/Linux/...)
- Provide services in the background



UEFI Forum

Unified Extensible Firmware Interface Forum

- Original EFI specification developed by Intel, 1999 – 2001
- Specification taken over by non-profit, collaborative trade organization in 2005 – UEFI Forum (<http://www.uefi.org>)



Insyde is one of the **9**
“Initial Promoters”, the
only promoter from Taiwan

11 Promoters now

AMD, Intel, Microsoft, Dell, HP, IBM,
Lenovo, AMI, Insyde, Phoenix,
Apple, ARM

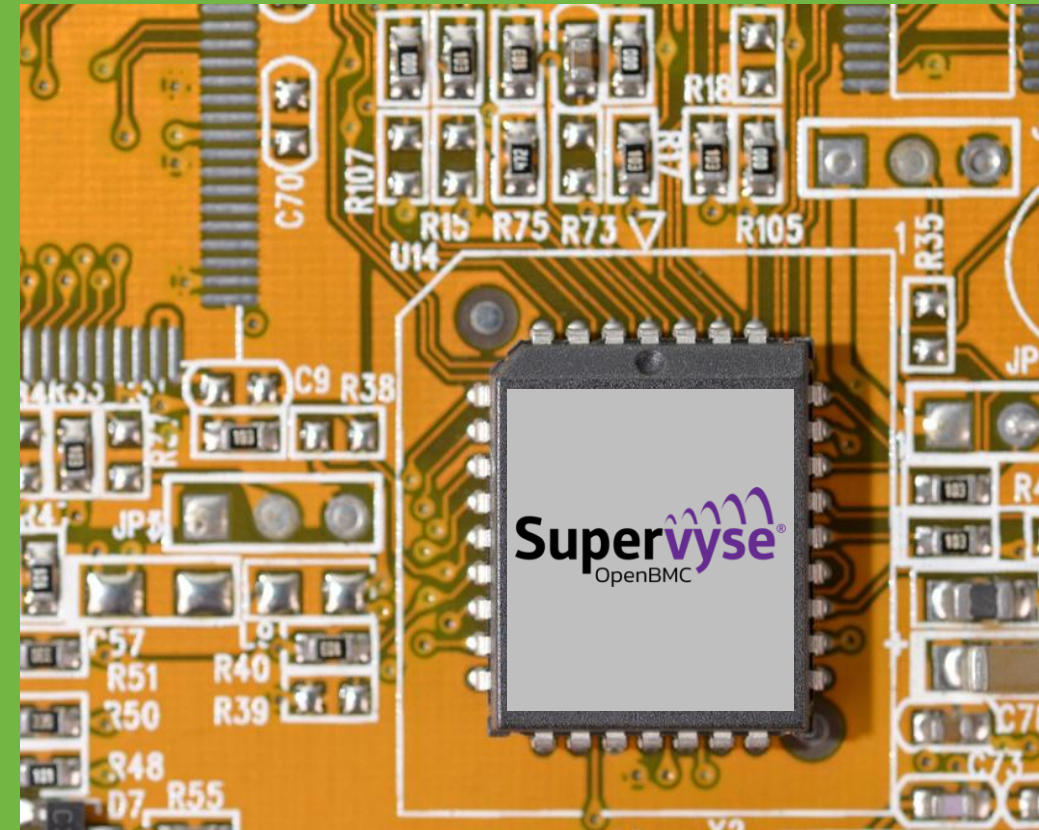
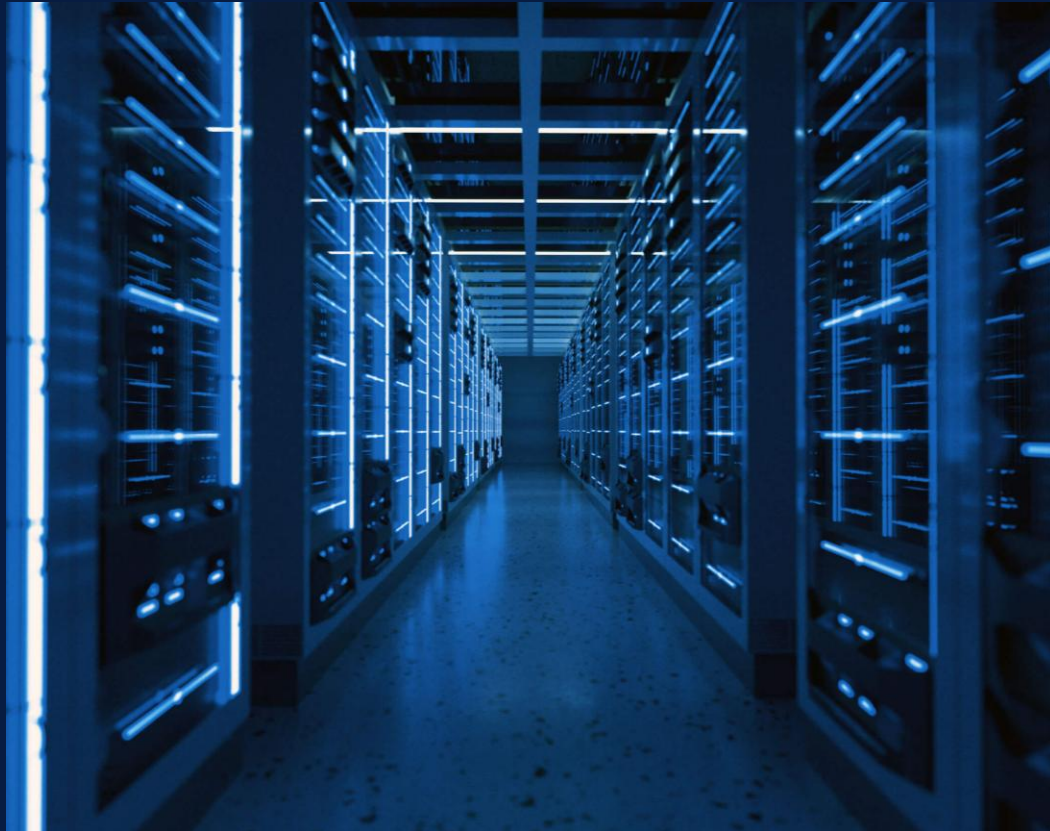
51 Contributors

Google, NVIDIA, Qualcomm, Broadcom,
Oracle, Cisco, Red Hat, Linaro, VMware,
Linux Foundation,....., etc.

More than
200 Adopters

BMC – OpenBMC Firmware

OpenBMC is an open-source firmware project used for managing Baseboard Management Controllers (BMCs) in servers, storage, and networking devices. It enables remote monitoring, management, and recovery of systems independent of the main operating system.

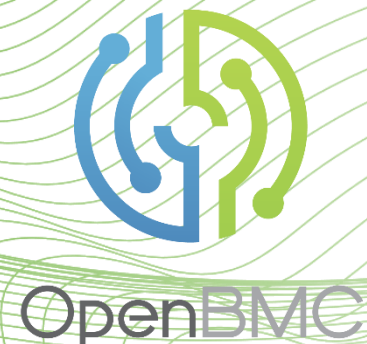


OpenBMC

The **OpenBMC community** is an open-source, collaborative group of companies, developers, and Since 2018, it has been a Linux Foundation project, driving open **standards for server management firmware**.

(<https://www.openbmc.org/>)

- Standardizes firmware interfaces using modern technologies like D-Bus and Redfish.
- Encourages open collaboration among hardware vendors (e.g., IBM, Google, Intel, Meta), software engineers, and system integrators.
- Maintains public codebases, documentation, and design discussions through Linux Foundation stewardship, utilizing platforms like GitHub and community mailing lists for collaboration and transparency



Sine **2022**
Insyde was the first IBV to announce the production level of OpenBMC software.

50+ **Contributors**

Google, Meta, IBM, Microsoft, ARM, Intel, AMD, Aspeed, HPE, Ampere, NVIDIA, Linux Foundation,....., etc.

9 **Founding Members**

Facebook, Google, IBM, etc.,

More than
200 **Adopters**

Product Portfolio



Product market application

Client Computing

Notebook, Tablet, AIO, and Desktop



Server & Storage

Data Center, Enterprise Server Storage, and Networking



Embedded & Edge

POS, Drone, Kiosk, ATM, Robot, Car system..



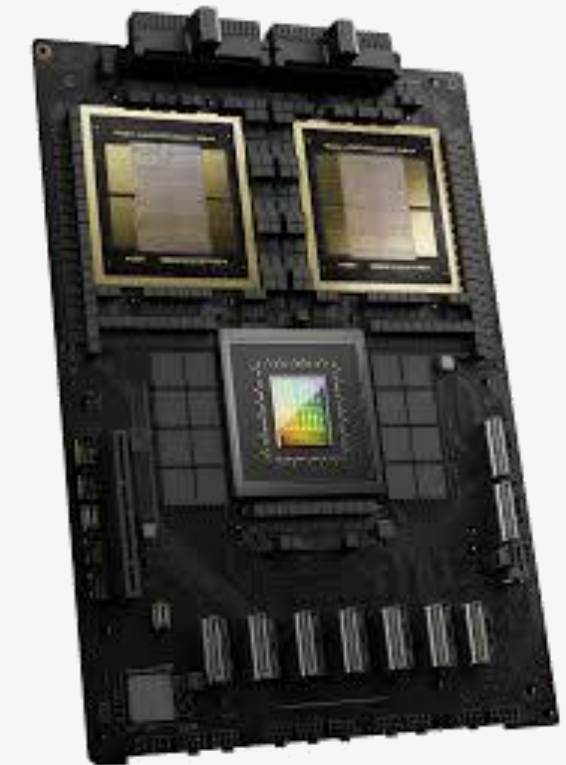
Accelerate with **Insyde**

Insyde is helping its customers accelerate the development and adoption of the latest AI-focused technologies and compute platforms

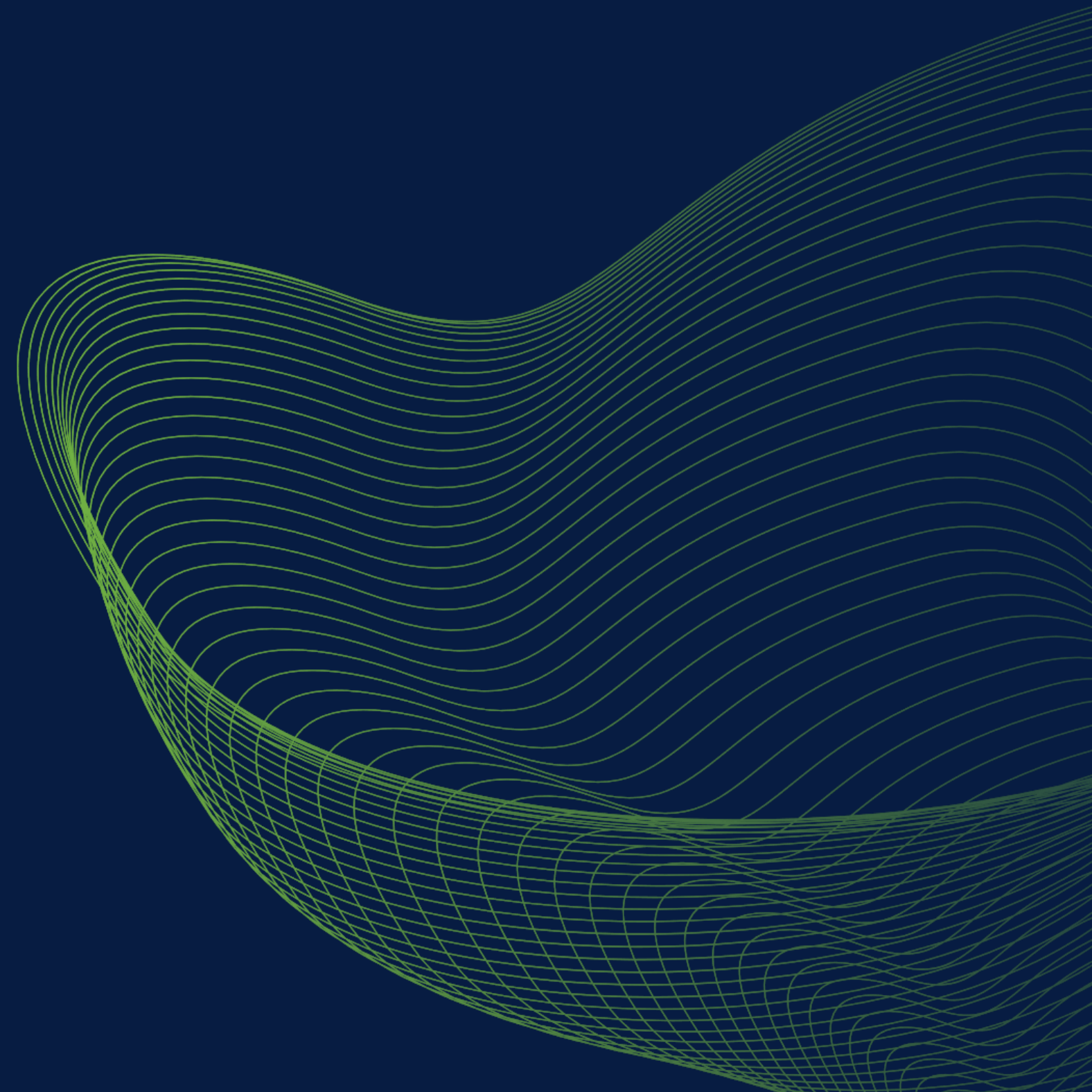
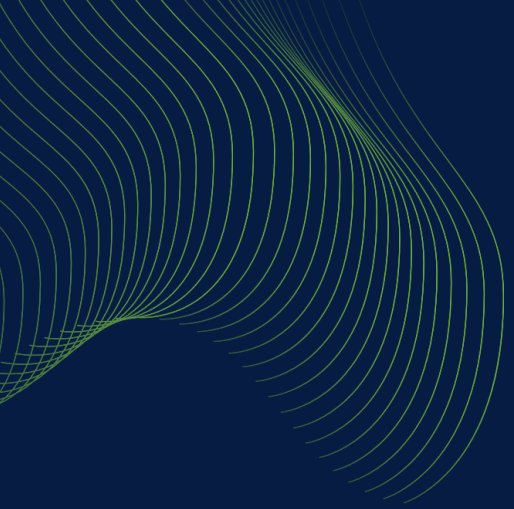
Today's Copilot+ AI PCs Are
Powered by InsydeH2O[®]



Firmware for Advanced Server
Compute Platforms Designed
for Demanding AI & HPC
Workloads



Recent Update



Support for Major Industry Standards

arm
SystemReady

CXL Compute Express Link®

DMTF

Redfish

fido™
ALLIANCE

FTIA

NIST
Security Standards

OpenBMC

OPEN
COMMUNITY®

PCI EXPRESS®

THUNDERBOLT™

TRUSTED COMPUTING GROUP

UEFI

CERTIFIED USB™

WiFi™
ALLIANCE

Strong Partnerships with Industry Leaders

AMD 

arm

A SPEED

 **Astera Labs**®

 **BROADCOM**

intel®


MICROCHIP

 **MARVELL**™

 **Microsoft**

 **NVIDIA**

Qualcomm

Trusted Supplier to Leading Companies

 **Client Computing**

 **AI, HPC, Data Center**

 **Networking, IoT & Embedded**

Insyde Helps Silicon Vendors and PC OEMs Deliver Leading Edge Products @ CES 2026



50+ designs across 3 silicon vendors and 5 PC OEMs start to ship in Q1'2026



Zenbook/ProArt/Vivobook(WOA)



Aspire/Nitro/Predator/Swift



Yoga Mini i



IdeaPad/Legion/Yoga/ThinkBook/ThinkCentre



HyperX, OmniBook 3/Ultra



XPS/Alienware



MegaBook 2 in 1 Laptop



Note U X1-26-100



WD2-K3



Insyde Supervyse® OPF Ready for ASPEED 8th Generation BMC chips



Next-Gen Silicon Support

First-to-market support for Aspeed's AST2700 (Quad-core, 12nm/28nm) ensures day-one readiness for upcoming server architectures.

Quantum-Ready Security

Industry-leading integration of Caliptra 2.1 Root of Trust and Post-Quantum Cryptography (PQC) algorithms (ML-DSA, L KEM) to meet NIST SP 800-193 standards.

Enhanced Telemetry

Deep hardware-software synergy allows for "Anti-Tamper" protection, Voltage Glitch Detection, and real-time intrusion monitoring.

New AI Racks Provide Many Opportunities For **Insyde** Firmware



CDU Thermal Management
Precision control of CDUs for high-wattage heat dissipation



Intelligent Power Management
Direct management of Power Shelves (PSU/BBU) for peak shaving and load balancing



Compute Trays
Unifying management across heterogeneous silicon.



Switch Trays
Seamless integration of High-speed scale out and scale up switches connectivity management.

InsydeH2O® & Supervyse® OPF expands firmware utility beyond the motherboard, acting as the single point of management for the entire AI rack's power, thermal, and compute system.

Recent Industry Events 2025

Snapdragon Early Access & Boot Camps



2025 Qualcomm Snapdragon Compute Ecosystem Summit in Taipei



Insyde Joins First Intel DCDC in India



Recent Industry Events 2026



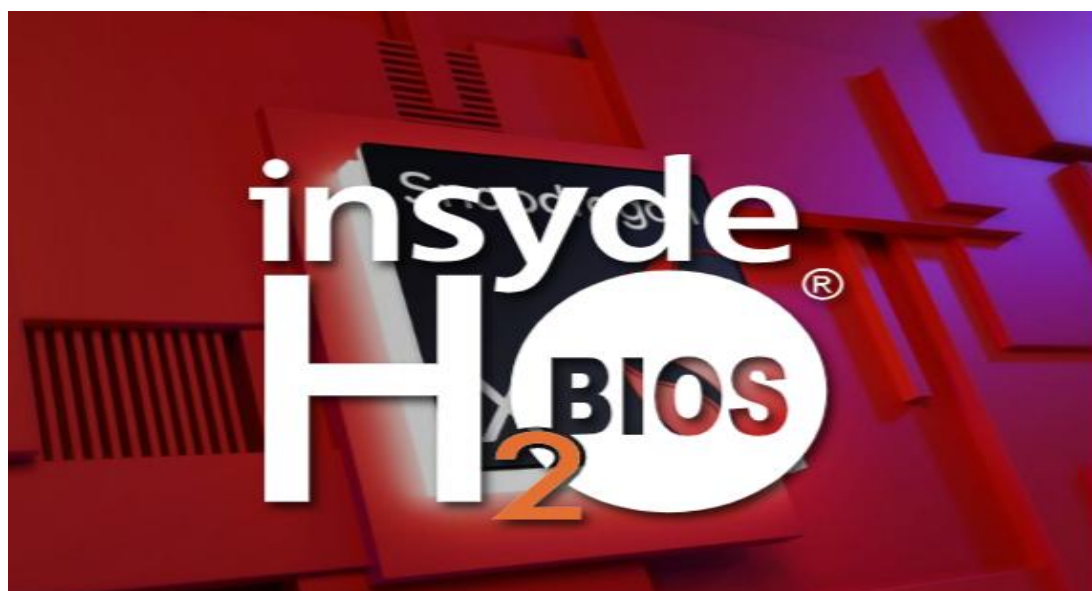
2026年03月10日 - 2026年03月12日

Embedded World 2026

場地:

NürnbergMesse GmbH
Messezentrum 1
90471 Nürnberg, Germany

PR released 2025 Q4

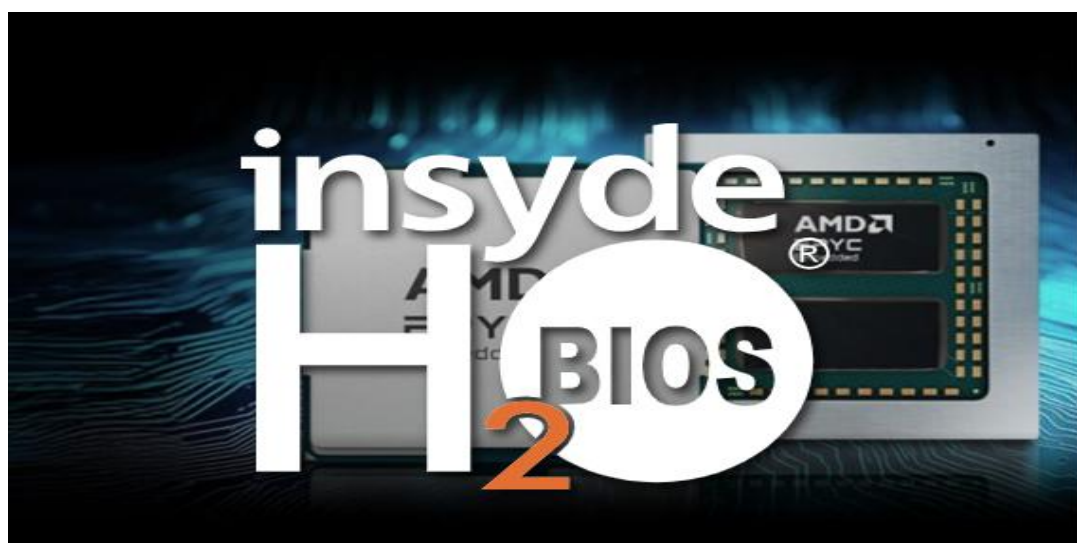


2025年12月29日

Insyde® Software 推出業界首款支援 Snapdragon X 系列平台 PC 的 BIOS 除錯解決方案

H2ODDT™ PRO 釋放強大除錯能力，加速 SNAPDRAGON 平台 PC 的開發流程

[閱讀公告 >](#)



2025年12月9日

Insyde Software 以支援 AMD EPYC™ Embedded 2005 系列之 UEFI BIOS，點燃次世代嵌入式效能平台的的新動能

InsydeH2O® UEFI BIOS 加速高效能、節能型網路、儲存與工業系統的產品部署

[閱讀公告 >](#)



2025年11月10日

系軟體於 Arm Unlocked Taipei 領袖峰會上 探討 AI 基礎架構的遙測技術

本次演講旨在強調專用韌體對 Arm Total Design 合作夥伴及其他公司在 AI 基礎架構管理中的重要性

[閱讀公告 >](#)

PR released 2025 Q4



2025年11月4日

**Insyde® Software 於 2025 英特爾 Client PC 生態鏈
群英會展示 AI 驅動的韌體領導力**

[Read the announcement >](#)



2025年10月14日

**Insyde® Software 加入 Arm Total Design 生態系
統，推動 AI 時代的伺服器基礎建設**

專屬韌體、開發工具與晶片合作計畫，加速 Arm Neoverse CSS 設計開發

[Read the announcement >](#)



2025年10月13日

**系微與 Astera Labs 攜手合作推動開放機架架構，強化
其在 OpenBMC 領域的領導地位**

為 AI 基礎架構 2.0 提供經過驗證的 OpenBMC 系統可管理性

[Read the announcement >](#)

PR released 2025 Q4



2025年10月8日

Insyde Software 於 2025 年OCP Global Summit 推動創新 AI 基礎架構

透過與重要的業界夥伴關係、技術演講與合作展示，展現領導地位

[Read the announcement >](#)

PR released 2026



2026年02月3日

Insyde® Software領先業界，率先於 Intel® Oak Stream 平台實現業界首次 OpenBMC 韌體開機

Supervyse® OPF OpenBMC 藉由 ASPEED 的新一代 BMC 晶片達成里程碑

[閱讀公告 >](#)

[新聞與活動 - 系微股份有限公司](#)

Financial Review



Quarterly Consolidated Income Statement

In NT\$ Thousands

	Q3'25	Q2'25	Q3'24	QoQ%	YoY%
Net Sales	426,441	404,349	413,372	5.46	3.16
COGS	113,345	112,100	101,535	1.11	11.63
Gross Profit	313,096	292,249	311,837	7.13	0.40
Gross margin	73.42%	72.28%	75.44%		
Operating Expense	207,782	208,999	207,038	-0.58	0.36
Operating Income	105,314	83,250	104,799	26.50	0.49
Operation Margin	24.70%	20.59%	25.35%		
Non-Op Inc/(Exp)	5,643	(20,346)	5,378	-127.74	4.93
Income before Tax	110,957	62,904	110,177	76.39	0.71
Net Income	84,459	47,579	88,487	77.51	-4.55
Net Margin	19.81%	11.77%	21.41%		
EPS	1.85	1.04	1.94		

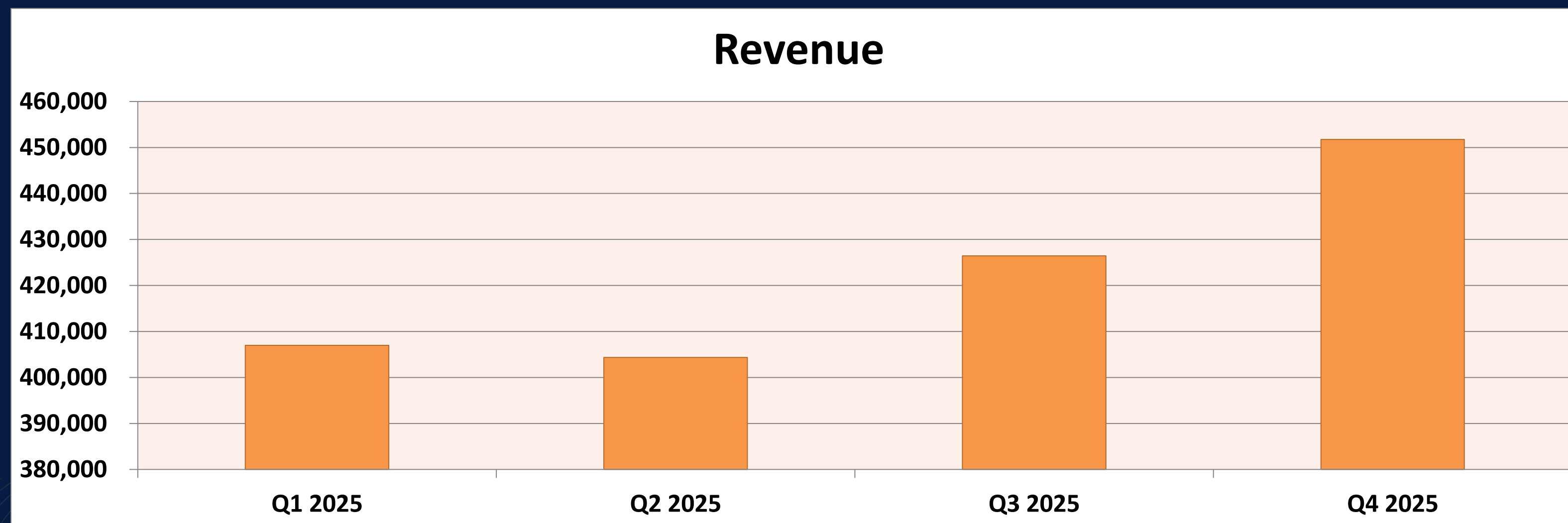
Consolidated Balance Sheet Summary

Selected Items from
Balance Sheet (NT\$ Millions)

	Q3'25		Q2'25		Q3'24	
	Amount	%	Amount	%	Amount	%
Current Assets	1,347.6	87.0%	1,584.1	88.6%	1,276.8	84.2%
Fixed Assets	91.7	5.9%	83.3	4.6%	87.6	5.8%
Net PP&E and other assets	110.1	7.1%	121.5	6.8%	152.3	10.0%
Total Assets	1,549.4	100.0%	1,788.9	100.0%	1,516.7	100.0%
Current Liabilities	465.2	30.0%	799.2	44.7%	391.4	25.8%
Non Current Liabilities	29.5	1.9%	29.2	1.6%	56.1	3.7%
Total Liabilities	494.7	31.9%	828.4	46.3%	447.5	29.5%
Shareholders' Equity	1,054.7	68.1%	960.5	53.7%	1,069.2	70.5%

%

Revenue by Quarterly



NTD : 仟元	Q1.25	Q2.25	Q3.25	Q4.25
Revenue	406,978	404,350	426,440	451,746

Source Code Disclosure Fee

Customers pay for a set(s) of Insyde source code supporting a specific CRB* provided by IHV**.

Royalty Fee

Customers pay "per unit" fee to Insyde for their product shipped with Insyde's firmware on it.

NRE (Non-Recurring Engineering) Fee

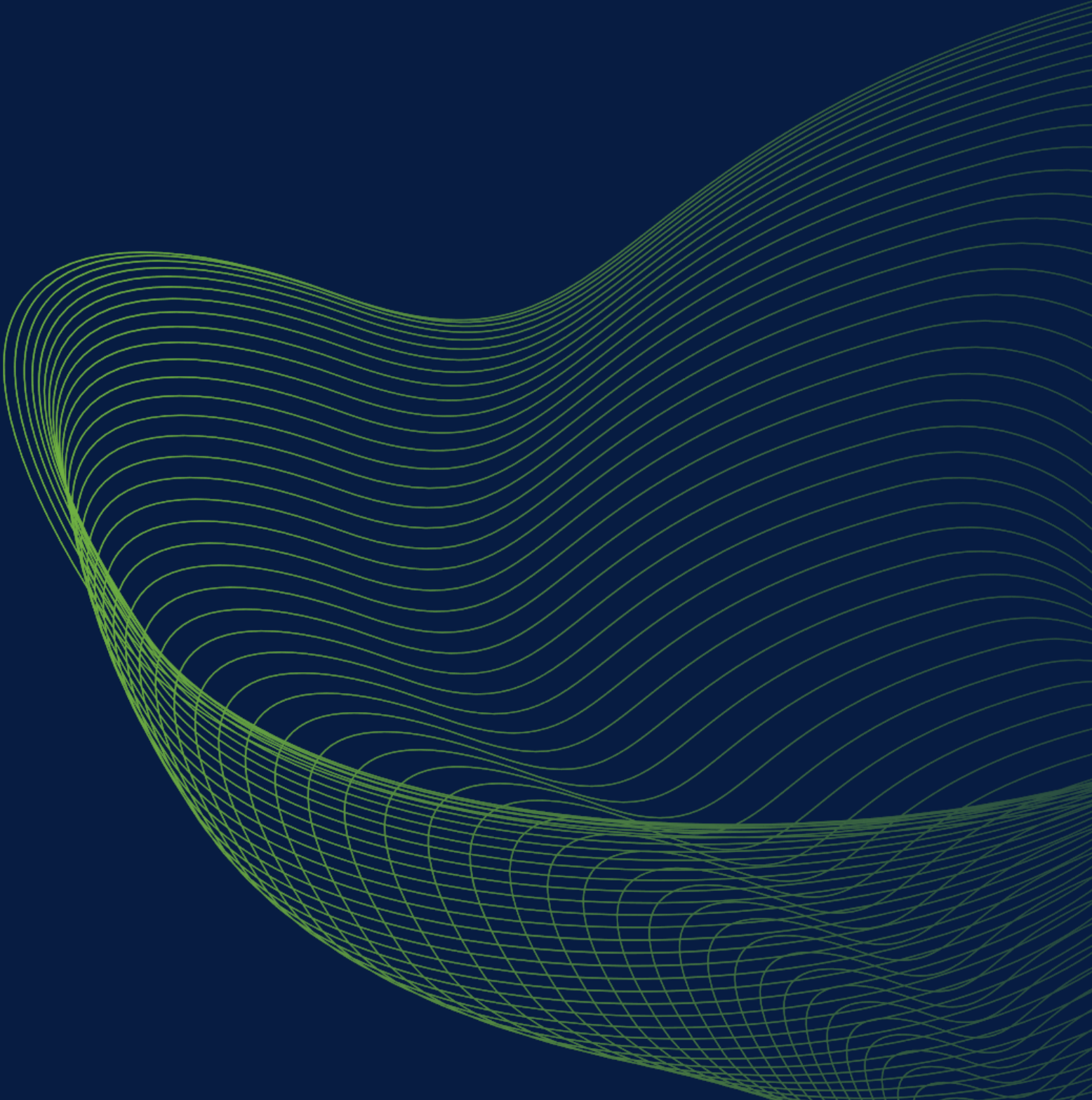
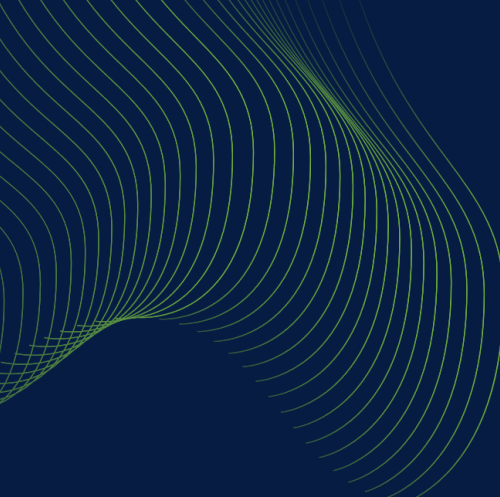
Customers pay for engineering service to complete the defined tasks in the SOW (Statement Of Work)

(NRE fee per day) * (number of working man days defined in the SOW)

Insyde's Revenue Types

* CRB: Customer Reference Board
** IHV: Independent Hardware Vendor, ex. Intel, AMD,..., etc.

Q&A





**For more information,
contact :**

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www.insyde.com

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